

Product Features (Fingerprint scanner module: SAP3523)

Main Specifications

- Module dimension : 35 x 23mm² with Oval-shaped sensor
- Pixel Array : 192 x 192
- Sensing Area : 9.6 x 9.6 mm²
- Resolution : 508DPI
- Gray Levels : 8 bits
- Enroll times: 1 times or 3 times
- Fingerprint database storage :3000 sets
- Module Interface : UART / USB
- Supply current @ voltage : TBD @ 3.3V
- Low Power Design with Metal Ring (Decorative)
- Finger Press Direction : 360 degrees arbitrary
- Sapphire Glass support to 9H hardness
- Anti-interference : ESD protection circuit, Reset circuit, anti-noise circuit, etc.
- ESD performance : +- 15KV Air / +-8KV Contact discharge
- Waterproof performance : IP67
- Module interface connector : Refer to the connector shape specification

Application

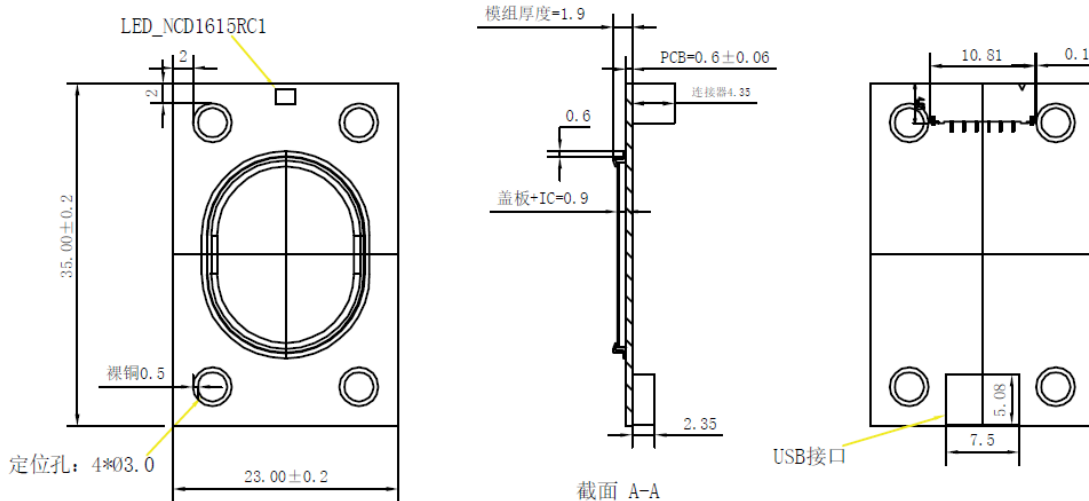
- Industry Fingerprint Applications
- Smart Password Lock devices
- Other Devices
- Time attendance

Overview

- This module is a capacitive touch fingerprint recognition module with a Sapphire glass surface, offering outstanding features such as anti-static, wear resistance, and corrosion resistance.
- It is combined with an exceptional fingerprint recognition algorithm and mature application software to deliver an excellent user experience in fingerprint industry applications

1、Module package specification

1.1 Module architecture:



1.2 Pin Descriptions(UART / USB)

Pin No.	Pin Name	Type	Function Description
1	GND	Ground	Module Ground
2	UART-RXD	Input	Serial port reception pin
3	UART-TXD	Output	Serial port transmission pin
4	3V3MCU	Power	Power for MCU
5	INT-OUT	Output	Serial port transmission pin
6	3V3SENSOR	Power	Power for sensor

Table 1-1.UART Pin descriptions

Pin No.	Pin Name	Type	Function Description
1	GND	Ground	Module Ground
2	NC	-	-
3	DP	-	USB signal
4	DN	-	USB signal
5	5V	Power	Power

Table 1-2. USB Pin descriptions

Power Saving Instructions : TBD

2. Related Characteristics

2.1 Module Operating Conditions

Condition		Mini value	Typical value	Max value
Operating Voltage	3V3MCU	2.8V	3.3V	3.6V
	/3V3SENSOR			
Temperature	Operating Temp	-40°C	-	85°C
	Storage Temp	-40°C	-	85°C

Table 2-1. Module Operating Conditions

2.2 Module DC Characteristics

3V3MCU / 3V3SENSOR		Mini value	Typical value	Max value
Operating Current	Working mode	--	TBD mA	TBD mA
	Detection Mode (5Hz)	TBD uA	TBD uA	TBD uA
	Idle Mode	--	TBD uA	--

Item	Symbol	Test Condition	Mini value	Typical	Max value	Unit
Input high-level voltage	VIH		0.9VDDIO	-	-	V
Input low-level voltage	VIL		-	-	0.3	V
Output high-level voltage	VOH		0.9VDDIO	-	-	V
Output low-level voltage	VOL		-	-	0.3	V

Table 2-2. Module DC Characteristics (AVDD = 3.3V)

2.3 Module Waterproof Performance

Test Item	Test Conditions	Test Qty	Test Result
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IP67	Put the sample into the water tank with the sample immersed in the ink. 1.2M / 1 hour.	5	TBD
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2.4 Module Electrostatic Performance

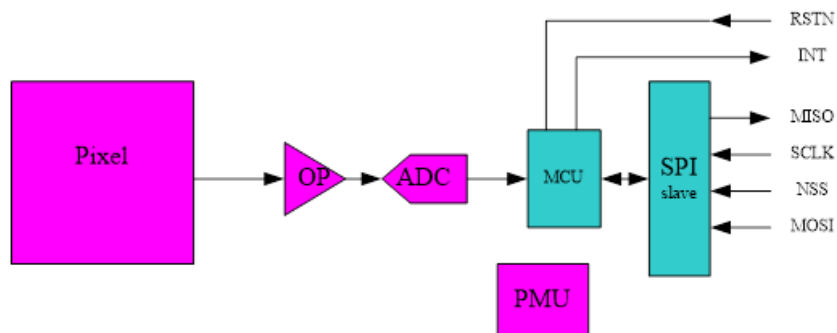
Test Item	Test Conditions	Test Qty	Test Result
ESD- Air discharge	±15kV	5	PASS
ESD- Contact discharge	±8kV	5	PASS

2.5 Algorithm Performance

- 1、Fingerprint Recognition time : <=1.5 seconds
- 2、Biometric False Acceptance Rate (FAR) TBD % , False Rejection Rate (FRR) TBD %
- 3、Fingerprint Storage Capacity 3000 / 5000 fingerprints.

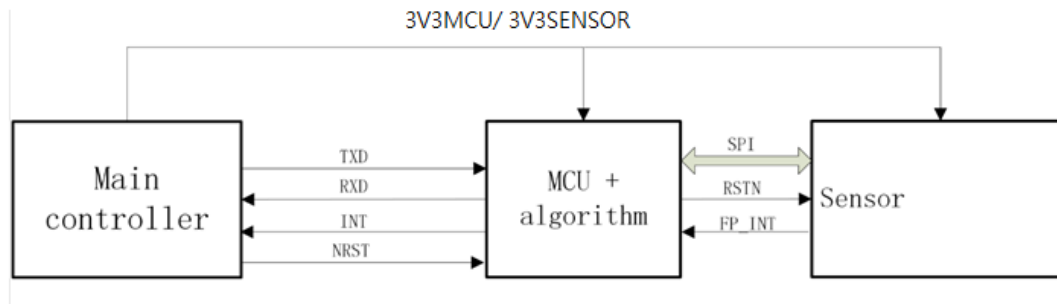
3.Operating Principles

3.1 Module Sensor Principle Block Diagram



Illustrated in Figure 3-1 The operating principle block diagram of the module

3.2Module block diagram



This module is a highly integrated fingerprint image acquisition module, mainly composed of the fingerprint sensor with algorithm chip, inside excellent fingerprint algorithm. Brief description is as follows:

- 1)Sensor chip : 192x192 pixel array , capable of capturing fingerprint image data from the corresponding area when a finger is touched.
- 2)Interface : Uart interface, MCU and INT to main controller
- 3)Algorithm MCU : Contains excellent fingerprint algorithm for system flow control, image digital signal processing. etc.

3.3 Serial protocol

Adjustable serial communication protocol